SiHP6N40D



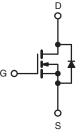


D Series Power MOSFET

PRODUCT SUMMARY					
V_{DS} (V) at T_J max.	450				
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	1.0			
Q _g max. (nC)	18				
Q _{gs} (nC)	3				
Q _{gd} (nC)	4				
Configuration	Single				

TO-220AB





N-Channel MOSFET

FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP6N40D-E3
Lead (Pb)-free and Halogen-free	SiHP6N40D-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400	v	
Gate-Source Voltage		M	± 30			
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30		
Continuous Drain Current (T_J = 150 °C)	V at 10.V	T _C = 25 °C	I _D	6	А	
	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		4		
Pulsed Drain Current ^a			I _{DM}	13	1	
Linear Derating Factor				0.8	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	104	mJ	
Maximum Power Dissipation			PD	104	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C		
Drain-Source Voltage Slope	T _J = 125 °C		dV/dt	24	V/ns	
Reverse Diode dV/dt ^d		uv/dt	0.48	V/ns		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^c	°C	

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.3 mH, $R_q = 25 \Omega$, $I_{AS} = 9.5$ A.

1.6 mm from case. C.

d. $I_{SD} \leq I_D$, starting $T_J = 25 \ ^{\circ}C$.

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PARAMETER Maximum Junction-to-Ambient Maximum Junction-to-Case (Drain)	SYMBOL	TYP.		MAY	1				
				MAX.		UNIT			
Maximum Junction-to-Case (Drain)	R _{thJA}	-	- 62				00 AM	0.001	
	R _{thJC}	- 1.2				°C/W			
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)							
PARAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT	
Static								I	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 μA	400	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			I _D = 250 μA	-	0.53	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}		V _{GS} , I _D =		3	-	5	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	-	± 100	nA	
, i i i i i i i i i i i i i i i i i i i	466	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	- μΑ		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			-	-		10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		$I_D = 3 A$	-	0.85	1.0	Ω	
Forward Transconductance	g _{fs}		= 50 V, I _D		-	1.7	-	S	
Dynamic	010						L	I	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	311	-	-		
Output Capacitance	C _{oss}			-	38	-			
Reverse Transfer Capacitance	C _{rss}			-	7	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	44	-	pF		
Effective output capacitance, time related ^b	C _{o(tr)}			-	54	-	1		
Total Gate Charge	Qa				-	9	18		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 320 \text{ V}$		-	3	-	nC		
Gate-Drain Charge	Q _{gd}				-	4	-		
Turn-On Delay Time	t _{d(on)}	V_{DD} = 400 V, I_D = 3 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	12	24			
Rise Time	t _r			.	-	11	22	-	
Turn-Off Delay Time	t _{d(off)}			-	14	28	- ns		
Fall Time	t _f			-	8	16			
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.9	-	Ω		
Drain-Source Body Diode Characteristic			ý - I						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6			
Pulsed Diode Forward Current	I _{SM}			-	_	24	A		
Diode Forward Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 3 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V		
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 3 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V		-	236	-	ns		
Reverse Recovery Charge	Q _{rr}			-	1.1	-	μC		
Reverse Recovery Current				-	9	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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SiHP6N40D

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

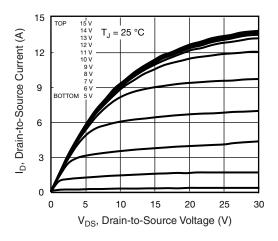


Fig. 1 - Typical Output Characteristics

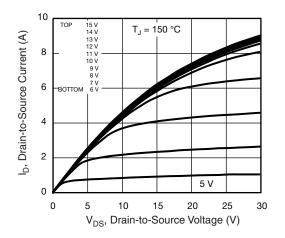


Fig. 2 - Typical Output Characteristics

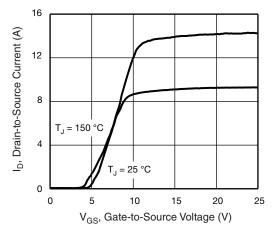


Fig. 3 - Typical Transfer Characteristics

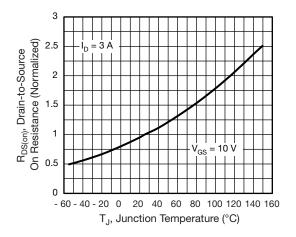


Fig. 4 - Normalized On-Resistance vs. Temperature

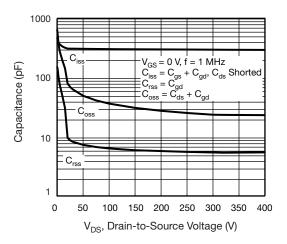
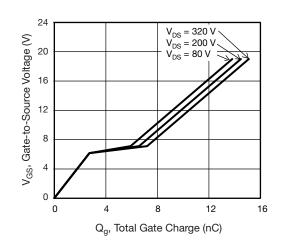


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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3 For technical questions, contact: <u>hvm@vishay.com</u>

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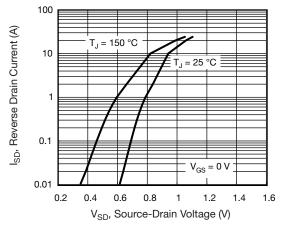


Fig. 7 - Typical Source-Drain Diode Forward Voltage

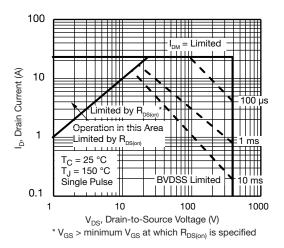


Fig. 8 - Maximum Safe Operating Area

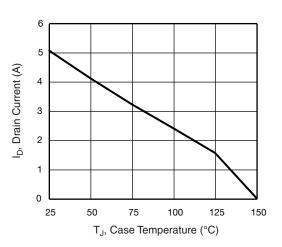


Fig. 9 - Maximum Drain Current vs. Case Temperature

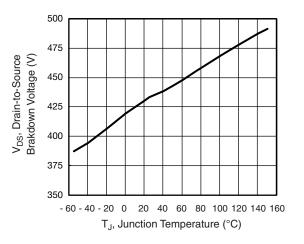


Fig. 10 - Temperature vs. Drain-to-Source Voltage

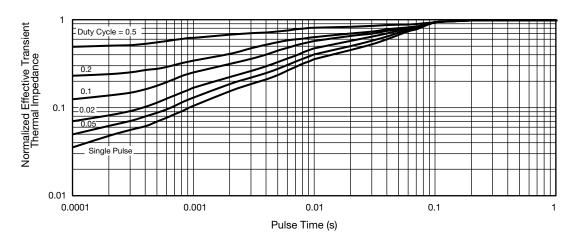


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

4

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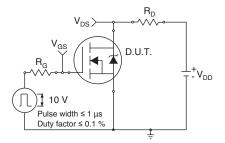


Fig. 12 - Switching Time Test Circuit

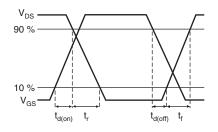


Fig. 13 - Switching Time Waveforms

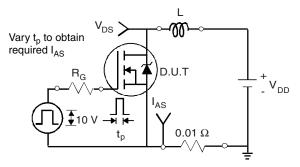


Fig. 14 - Unclamped Inductive Test Circuit

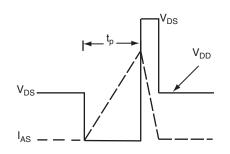


Fig. 15 - Unclamped Inductive Waveforms

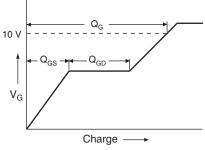


Fig. 16 - Basic Gate Charge Waveform

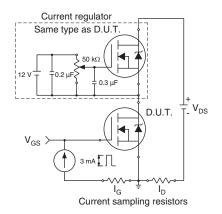


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

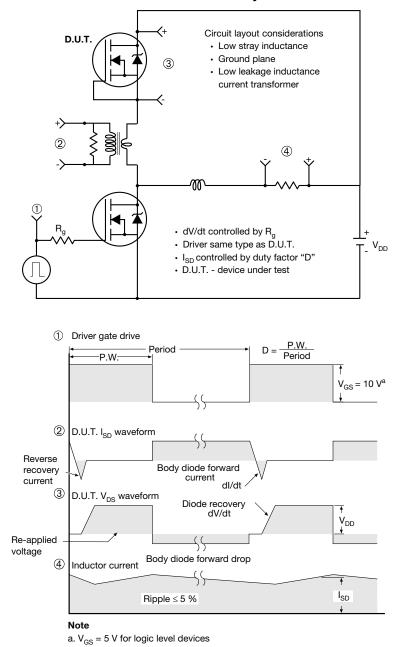


Fig. 18 - For N-Channel

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